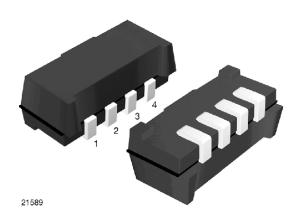


www.vishay.com

Vishay Semiconductors

IR Receiver Modules for Remote Control Systems



LINKS TO ADDITIONAL RESOURCES









DESCRIPTION

The TSOP95...W series devices are the latest generation miniaturized IR receiver modules for infrared remote control systems. These series provide improvements in sensitivity to remote control signals in dark ambient as well as in sensitivity in the presence of optical disturbances e.g. from CFLs.

The devices contain a PIN diode and a preamplifier assembled on a lead frame. The epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding.

The TSOP953..W and TSOP955..W series devices are designed to receive short burst codes (6 or more carrier cycles per burst). The third digit designates the AGC level (AGC3 or AGC5) and the last two digits designate the band-pass frequency (see table below). The higher the AGC, the better noise is suppressed, but the lower the code compatibility. AGC3 provides enhanced noise suppression and AGC5 provides maximized noise suppression. Generally, we advise to select the highest AGC that satisfactorily receives the desired remote code.

These components have not been qualified to automotive specifications.

FEATURES

- · Improved dark sensitivity
- · Improved immunity against optical noise
- Very low supply current
- · Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.0 V to 3.6 V
- Insensitive to supply voltage ripple and noise
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

MECHANICAL DATA

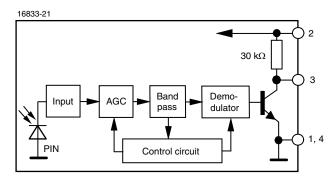
1, 4 = GND, $2 = V_S$, 3 = OUT

ORDERING CODE

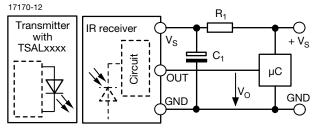
Taping:

TSOP95...WTT - top view taped, 2200 pcs/reel TSOP95...WTR - side view taped, 2300 pcs/reel

BLOCK DIAGRAM



APPLICATION CIRCUIT



 R_1 and C_1 recommended to reduce supply ripple for $V_S < 2.2 \text{ V}$



PARTS TABLE				
AGC		ENHANCED NOISE SUPPRESSION (AGC3)	MAXIMIZED NOISE SUPPRESSION (AGC5)	
Carrier frequency	30 kHz	TSOP95330W	TSOP95530W	
	33 kHz	TSOP95333W	TSOP95533W	
	36 kHz	TSOP95336W (1)	TSOP95536W	
	38 kHz	TSOP95338W (2)(4)	TSOP95538W	
	40 kHz	TSOP95340W	TSOP95540W	
	56 kHz	TSOP95356W	TSOP95556W ⁽³⁾	
Package		Heimdall no lens		
Pinning		1, 4 = GND, 2 = V _S , 3 = OUT		
Dimensions (mm)		6.8 W x 3.0 H x 2.35 D		
Mounting		SMD		
Application		Remote control		
Best choice for	Sest choice for (1) RCMM (2) RECS-80 Code (3) r-map (4) XMP-1, XMP-2		⁽³⁾ r-map ⁽⁴⁾ XMP-1, XMP-2	
Special options		 Extended temperature range: www.vishay.com/doc?82738 Narrow optical filter: www.vishay.com/doc?81590 Wide optical filter: www.vishay.com/doc?82726 		

Note

• 30 kHz and 33 kHz only available on written request

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		Vs	-0.3 to +3.6	V
Supply current		I _S	3	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		I _O	5	mA
Junction temperature		T _j	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

ELECTRICAL AND OPTI	ICAL AND OPTICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current	$E_{V} = 0, V_{S} = 3.3 V$	I _{SD}	0.25	0.37	0.45	mA
Supply current	$E_v = 40$ klx, sunlight	I _{SH}	-	0.50	-	mA
Supply voltage		Vs	2.0	-	3.6	V
Transmission distance	$E_v = 0$, test signal see Fig. 1, IR diode TSAL6200, $I_F = 50$ mA	d	-	16	-	m
Output voltage low	I _{OSL} = 0.5 mA, E _e = 0.7 mW/m ² , test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Test signal: XMP code	E _{e min.}	-	0.32	0.7	mW/m ²
Will ill latti il radiance	Test signal: NEC code	E _{e min.}	-	0.24	0.6	mW/m ²
Maximum irradiance	t_{pi} - 3.0/f ₀ < t_{po} < t_{pi} + 3.5/f ₀ , test signal see Fig. 1	E _{e max.}	30	-	-	W/m ²
Directivity	Angle of half transmission distance	Φ1/2	-	± 75	-	0

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

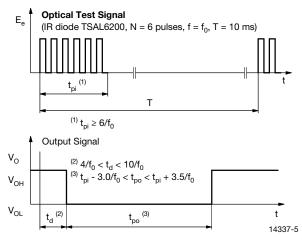


Fig. 1 - Output Delay and Pulse-Width

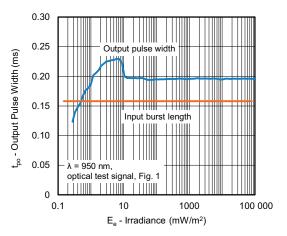
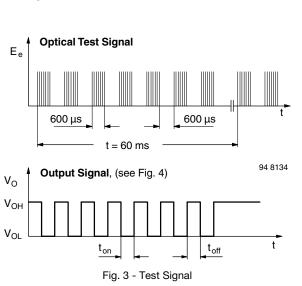


Fig. 2 - Pulse-Width vs. Irradiance in Dark Ambient



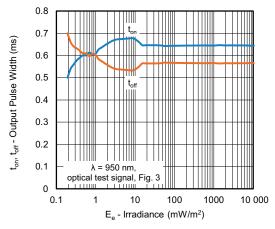


Fig. 4 - Pulse-Width vs. Irradiance in Dark Ambient

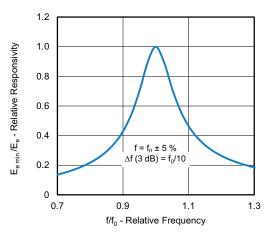


Fig. 5 - Frequency Dependence of Responsivity

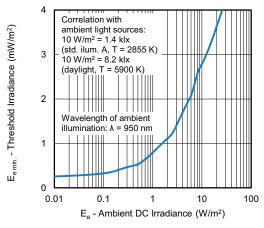


Fig. 6 - Sensitivity in Bright Ambient

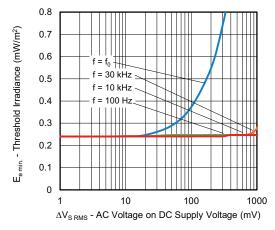


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

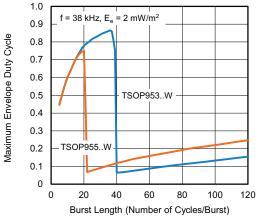
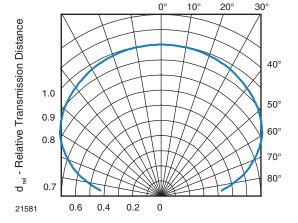


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length



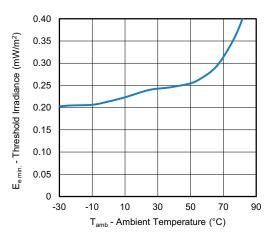


Fig. 9 - Sensitivity vs. Ambient Temperature

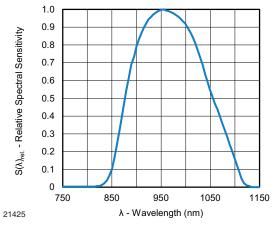


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

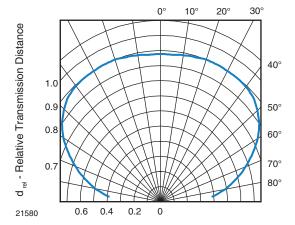


Fig. 11 - Horizontal and Vertical Directivity

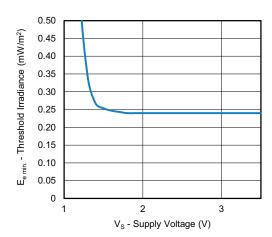


Fig. 12 - Sensitivity vs. Supply Voltage

SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14)

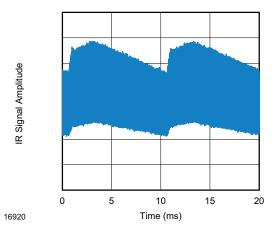


Fig. 13 - IR Emission from Fluorescent Lamp With Low Modulation

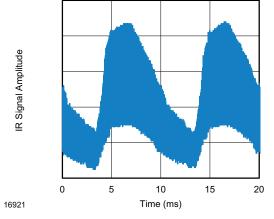


Fig. 14 - IR Emission from Fluorescent Lamp With High Modulation

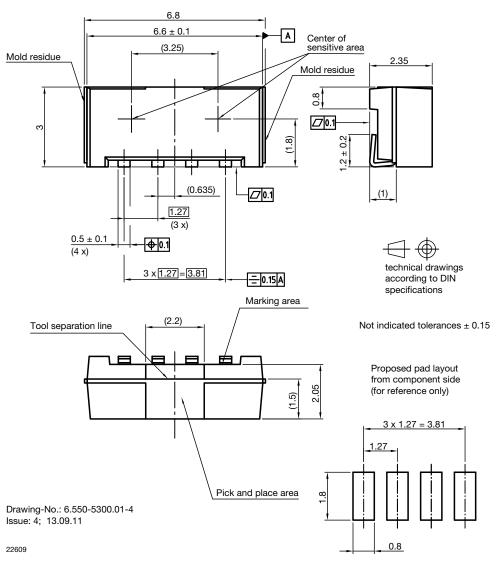
	TSOP953W	TSOP955W
Minimum burst length	6 cycles/burst	6 cycles/burst
After each burst of length A gap time is required of	6 to 20 cycles ≥ 8 cycles	6 to 38 cycles ≥ 8 cycles
For bursts greater than a minimum gap time in the data stream is needed of	20 cycles > 6 x burst length	38 cycles > 20 ms
Maximum number of continuous short bursts/second	2500	2500
RCMM code	Preferred	Yes
XMP-1 code	Preferred	Yes
r-map code	Yes	Preferred
RECS-80 code	Preferred	Yes
Suppression of interference from fluorescent lamps	Fig. 13 and Fig. 14	Fig. 13 and Fig. 14

Note

• For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP952..W, TSOP954..W, or TSOP956..W



PACKAGE DIMENSIONS in millimeters



ASSEMBLY INSTRUCTIONS

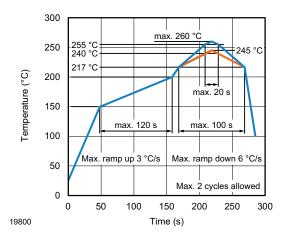
Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

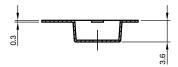
Manual Soldering

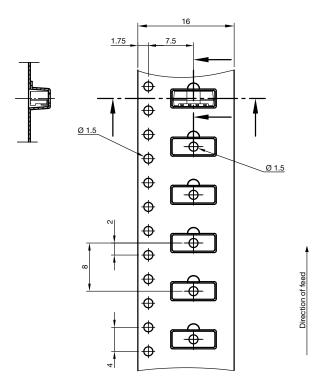
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP..TR DIMENSIONS in millimeters



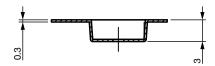


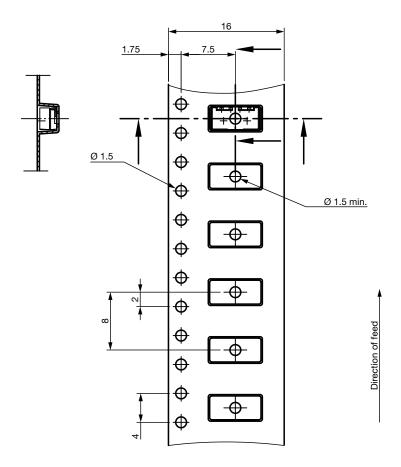
Drawing-No.: 9.700-5342.01-4

Issue: 2; 12.06.13



TAPING VERSION TSOP..TT DIMENSIONS in millimeters



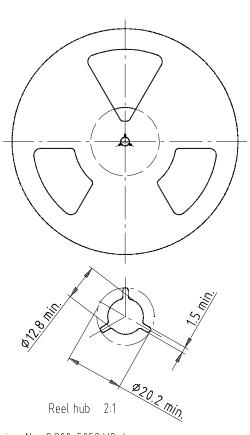


Drawing-No.: 9.700-5341.01-4

Issue: 3; 06.10.15

technical drawings according to DIN specifications

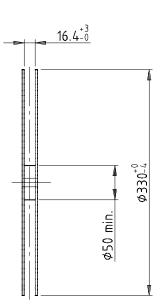
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734



Form of the leave open of the wheel is supplier specific.

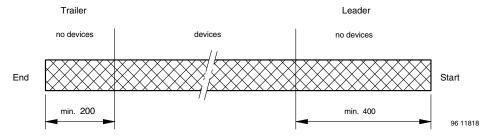
Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

LEADER AND TRAILER DIMENSIONS in millimeters

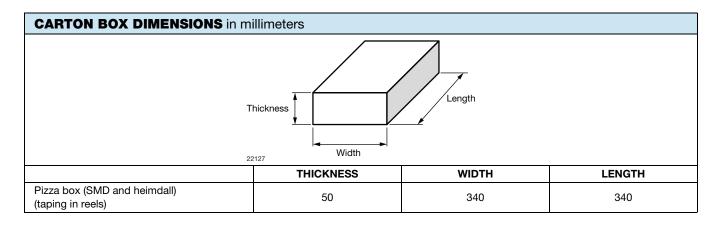


COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

OUTER PACKAGING

The sealed reel is packed into a pizza box.



LABEL

Standard bar code labels for finished goods

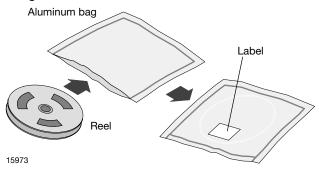
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)			
PLAIN WRITING	ABBREVIATION	LENGTH	
Item-description	-	18	
Item-number	INO	8	
Selection-code	SEL	3	
LOT-/serial-number	BATCH	10	
Data-code	COD	3 (YWW)	
Plant-code	PTC	2	
Quantity	QTY	8	
Accepted by	ACC	-	
Packed by	PCK	-	
Mixed code indicator	MIXED CODE	-	
Origin	xxxxxxx+	Company logo	
LONG BAR CODE TOP	TYPE	LENGTH	
Item-number	N	8	
Plant-code	N	2	
Sequence-number	X	3	
Quantity	N	8	
Total length	-	21	
SHORT BAR CODE BOTTOM	TYPE	LENGTH	
Selection-code	X	3	
Data-code	N	3	
Batch-number	X	10	
Filter	-	1	
Total length	-	17	



DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

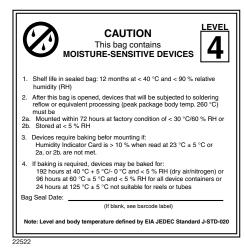
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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Vishay

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